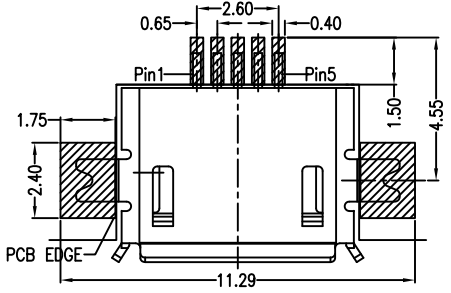
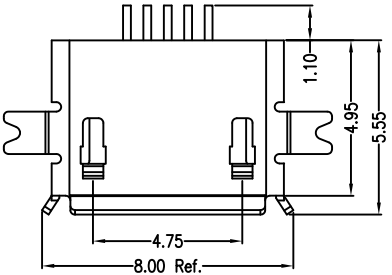
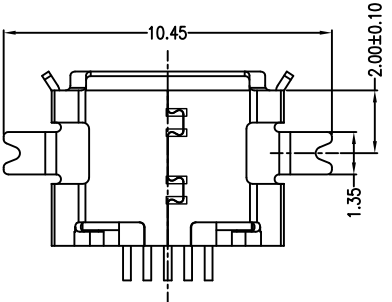
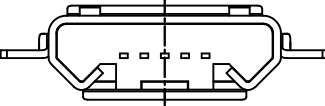
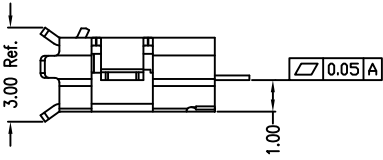
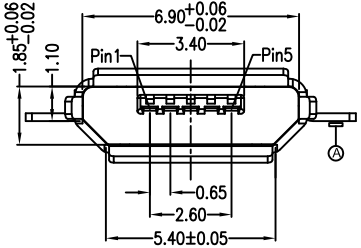
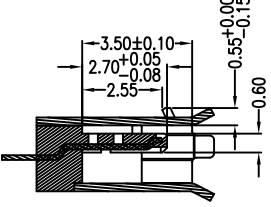


REV	MODIFICATION	DATE
A0	胶芯变更	2013. 12. 20



RECOMMENDED PCB LAYOUT
PCB图仅供参考



- Note:
- Material:
 - Housing: High temperature thermoplastic with g.f,UL94v-0
 - Contact: copper alloy,t=0.15mm
 - Shell: copper alloy,t=0.25mm
 - Specification:
 - Current rating:1,5PIN 1.8A Max/2,3,4PIN 1A Max.
 - Dielectric withstanding voltage: 100 V(ac) for 1 min.
 - Contact resistance: 30 mΩ Max.
 - Insulation resistance: 100 MΩ Min.
 - Total mating force: 3.57 Kgf Max.
 - Total unmating force: 1.0 Kgf Min.
 - Temperature range: -30°C~80°C

产品图 PRODUCT CHART DWG		易芯精密科技(浙江)有限公司 Easychips Precision Technology (Zhejiang) Co.,Ltd.				
公差一览表 TOLERANCE UNLESS OTHERWISE		单位	制图	制图料号	B920-ECF52A2021S10107 产品名称 MICRO 5S B型沉板式1.0两脚贴板有边LCP黑胶SMT端子1.1 PRODUCT NAME 角法 VIEW	
X.	±0.30	X.	±5.°	UNIT		MM
.X	±0.25	.X	±2.°	SCALE		1:1
.XX	±0.15	.XX	±1.°	DATE		2021-04-16
.XXX	±0.10	.XXX	±0.5°	核淮		APPD
		日期	2021-04-16	核淮	APPD	
		版本	REV	AD		